

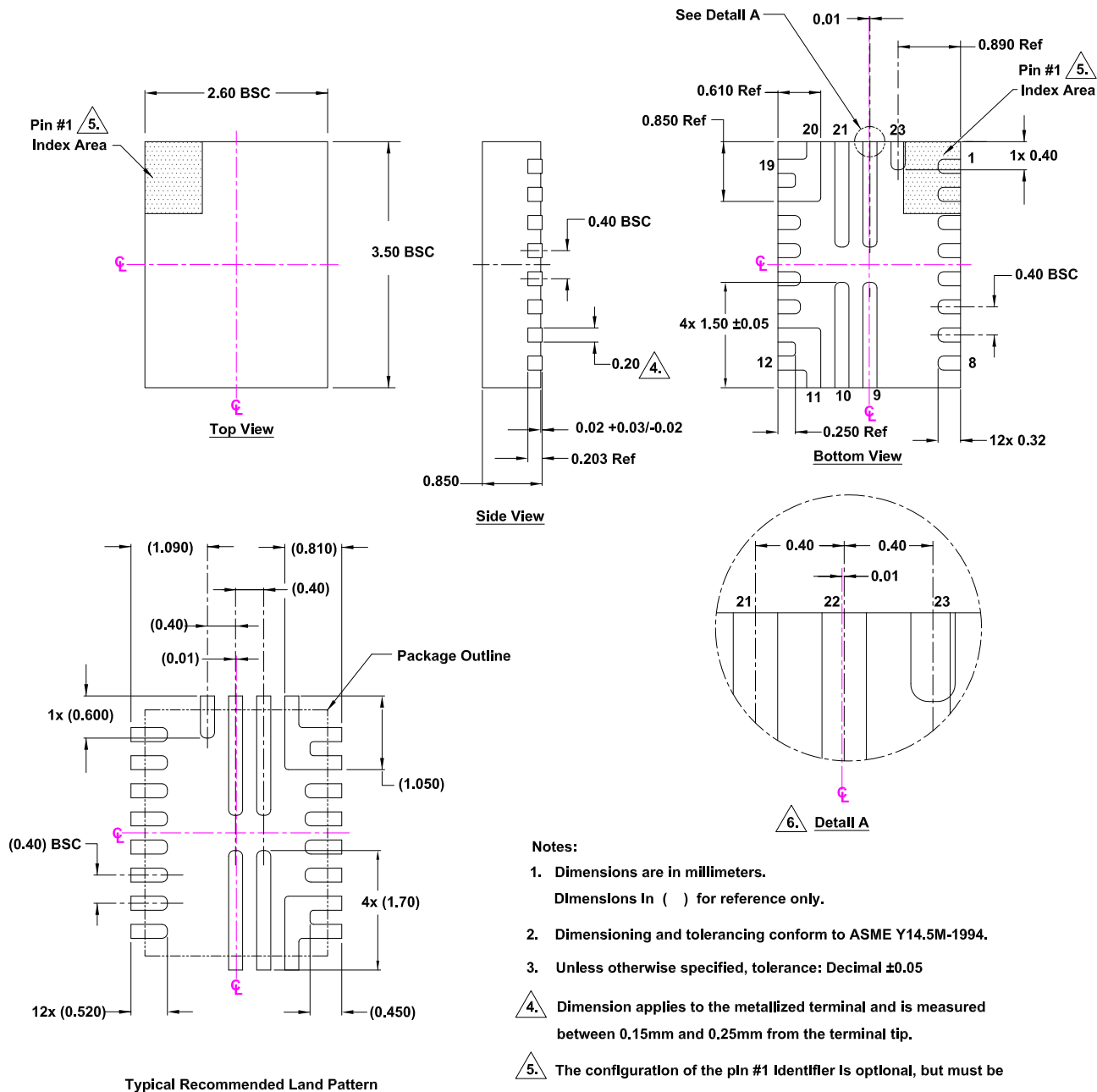
Plastic Packages for Integrated Circuits

Package Outline Drawing

L23.2.6x3.5

23 Ld Flip Chip Quad Flat No-Lead Package (FCQFN)

Rev2, 3/2021



Notes:

1. Dimensions are in millimeters.
Dimensions in () for reference only.
2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
3. Unless otherwise specified, tolerance: Decimal $\pm$ 0.05
4. Δ Dimension applies to the metallized terminal and is measured between 0.15mm and 0.25mm from the terminal tip.
5. Δ The configuration of the pin #1 Identifier is optional, but must be located within the zone indicated. The pin #1 Identifier is either a mold or mark feature.
6. Δ C/L of pin 22 and pin 9 are off set from package centerline by 0.010mm